Vishay Siliconix



THERMAL RESISTANCE RATINGS

Parameter	Symbol Typical		Maximum	Unit		
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	12.5	16	C/W	

Notes:

a. T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 110 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	190			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		200		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	ID = 230 μA		- 3.0			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.6		1.4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 16 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 190 V, V _{GS} = 0 V			1	μΑ	
		V_{DS} = 190 V, V_{GS} = 0 V, T_{J} = 85 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	1			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 0.36 A		3.0	3.8	Ω	
		V _{GS} = 2.5 V, I _D = 0.35 A		3.2	4.2		
		V _{GS} = 1.8 V, I _D = 0.15 A		3.5	17.0	1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 0.36 A		2		S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		90		pF	
Output Capacitance	C _{oss}			5			
Reverse Transfer Capacitance	C _{rss}			3			
Takal Oaka Okanaa		$V_{DS} = 95 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.47 \text{ A}$		3	4.5	nC	
Total Gate Charge	Qg			1.4	2.1		
Gate-Source Charge	Q _{gs}	$V_{DS} = 95 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 0.47 \text{ A}$		0.25			
Gate-Drain Charge	Q _{gd}			0.40			
Gate Resistance	Ř _a	f = 1 MHz		2.3		Ω	
Turn-On Delay Time	t _{d(on)}			10	15	- ns	
Rise Time	ťr	V_{DD} = 95 V, R_L = 250 Ω		15	25		
Turn-Off DelayTime	t _{d(off)}	${\rm I_D}\cong 0.38~{\rm A},~{\rm V_{GEN}}=4.5~{\rm V},~{\rm R_g}=1~{\rm \Omega}$		25	40		
Fall Time	ťf			15	25		
Turn-On Delay Time	t _{d(on)}			3	10		
Rise Time	t _r	V_{DD} = 95 V, R_L = 250 Ω		12	20		
Turn-Off DelayTime	t _{d(off)}	${ m I}_{ m D}\cong~$ 0.38 A, ${ m V}_{ m GEN}$ = 10 V, ${ m R}_{ m g}$ = 1 Ω		10	15		
Fall Time	t _f	3		10	15	1	
Drain-Source Body Diode Characteristic	cs					•	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			0.95		
Pulse Diode Forward Current	I _{SM}	-	1		1	A	
Body Diode Voltage	V _{SD}	I _S = 0.5 A, V _{GS} = 0 V	1	0.8	1.2	V	



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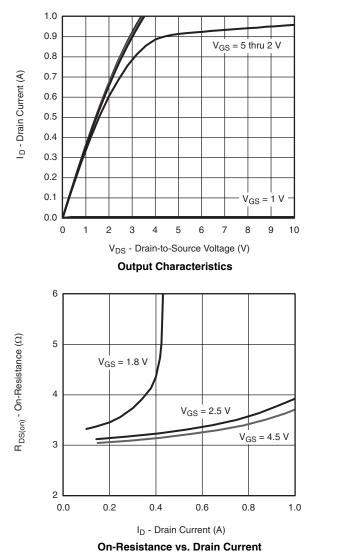
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Symbol Test Conditions		Тур.	Max.	Unit	
Drain-Source Body Diode Characteristics							
Body Diode Reverse Recovery Time	t _{rr}	I _F = 0.5 A, dl/dt = 100 A/μs, T _J = 25 °C		45	70	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			45	70	nC	
Reverse Recovery Fall Time	t _a			21		ns	
Reverse Recovery Rise Time	t _b			24			

Notes:

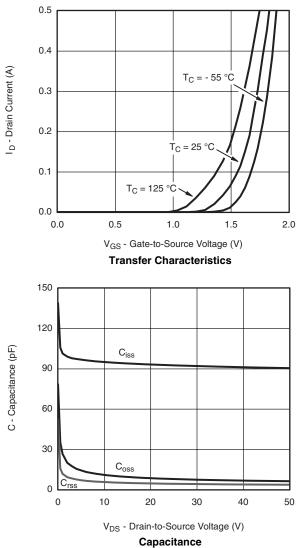
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



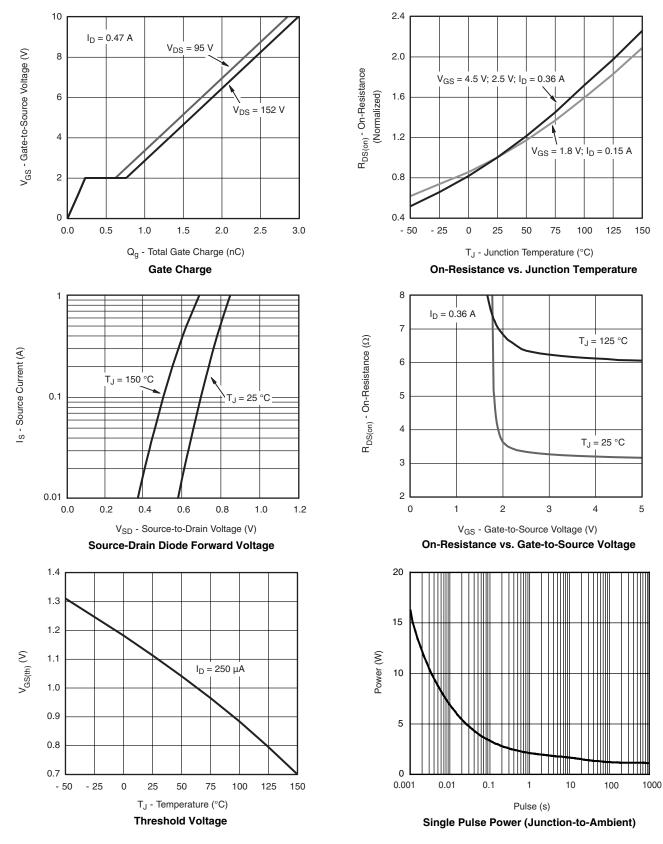
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted



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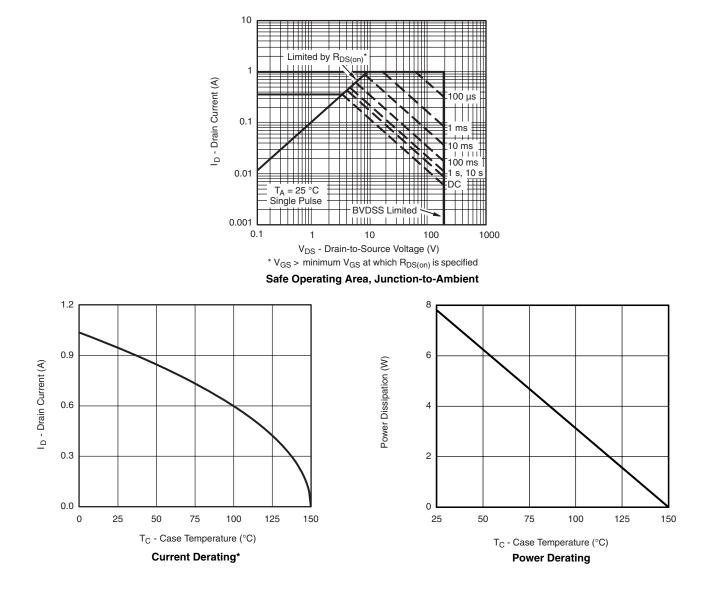


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SiA950DJ Vishay Siliconix

TYPICAL CHARACTERISTICS $T_A = 25 \ ^\circ C$, unless otherwise noted

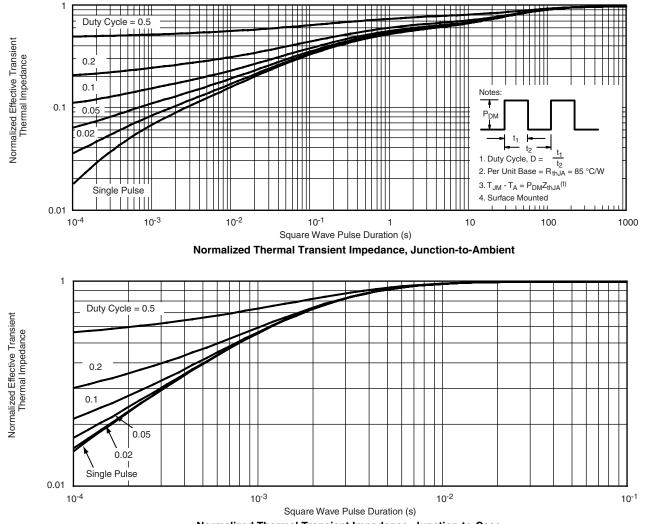


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64712.

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